



DMP4011SPSWQ

40V P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on) max	I _{D MAX} Tc = +25°С
-40V	$10m\Omega @ V_{GS} = -10V$	-76A
	$14m\Omega @ V_{GS} = -4.5V$	-58A

Description

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- **DC-DC** converters
- Power-management functions
- Analog switches

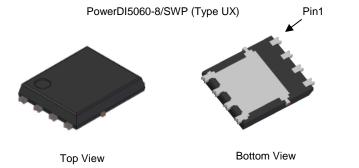
Features and Benefits

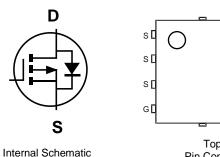
- 100% Unclamped Inductive Switch (UIS) Test In Production •
- Low On-Resistance •
- Fast Switching Speed •
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2) •
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMP4011SPSWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish 100% Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)







ПD Ŋр

ΠD

Πр

Ordering Information (Note 4)

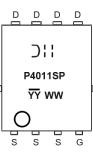
Part Number	Paakaga	Packing		
	Package	Qty.	Carrier	
DMP4011SPSWQ-13	PowerDI5060-8/SWP (Type UX)	2,500	Reel	

Note: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See http://www.diodes.com/quality/lead_free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



⊃ : : = Manufacturer's Marking P4011SP = Product Type Marking Code <u>YY</u>WW = Date Code Marking YY = Year (ex: 23 = 2023) WW = Week (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	-40	V		
Gate-Source Voltage			V _{GSS}	±20	V
	Steady	Tc = +25°C	1-	-76	А
Continuous Drain Current V _{GS} = -10V (Note 6)	State	$T_{\rm C} = +70^{\circ}{\rm C}$	ID	-61	
Continuous Drain Current V_{GS} = -10V (Note 5)	Steady State	T _A = +25°C	- ID	-11.7	А
		T _A = +70°C		-9.4	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		ldм	-300	А	
Maximum Body Diode Continuous Current (Note 5)		ls	-8.9	А	
Pulsed Source Current (10µs Pulse, Duty Cycle = 19	lsм	-300	А		
Avalanche Current (Note 7) L = 1mH	las	-22	А		
Avalanche Energy (Note 7) L = 1mH			Eas	250	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 8)	T _A = +25°C	PD	1.3	W
Thermal Resistance, Junction to Ambient (Note 8)	Steady State	Reja	96.4	°C/W
Total Power Dissipation (Note 5)	T _A = +25°C	PD	2.3	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	55	°C/W
Thermal Resistance, Junction to Case (Note 6)		Rejc	1.3	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
6. Thermal resistance from junction to soldering point (on the exposed drain pad).
7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
8. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided. Notes:



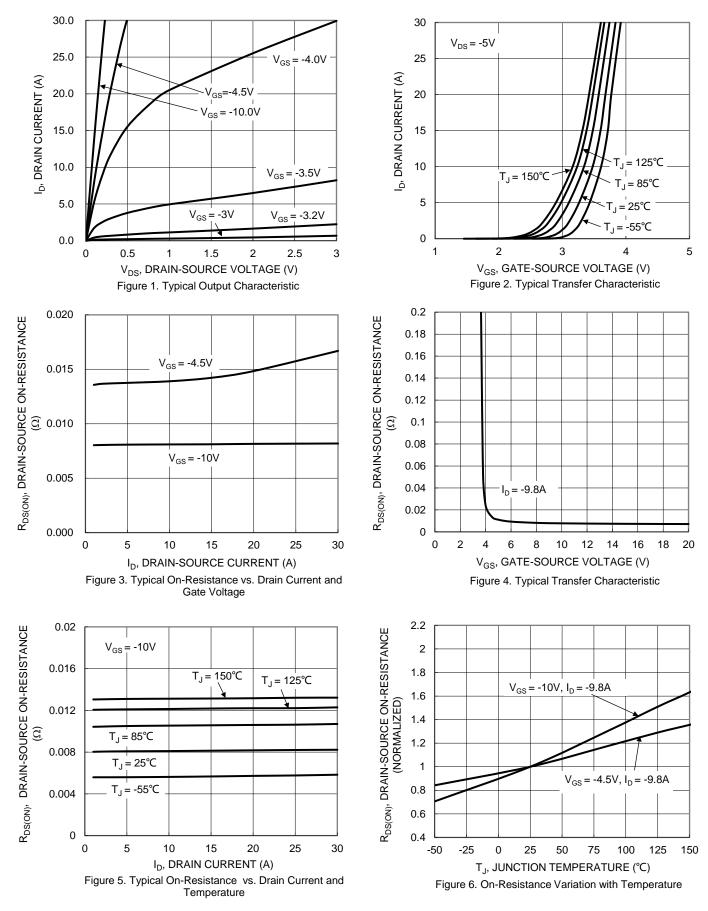
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)	•						
Drain-Source Breakdown Voltage	BV _{DSS}	-40	_		V	$V_{GS} = 0V, I_D = -250 \mu A$	
Zero Gate Voltage Drain Current	I _{DSS}		_	-1	μA	$V_{DS} = -32V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}		_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	-1.0	-1.9	-2.5	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	
Static Drain-Source On-Resistance	D	_	6	10	mΩ	$V_{GS} = -10V, I_D = -9.8A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	10	14	11122	$V_{GS} = -4.5V, I_D = -9.8A$	
Diode Forward Voltage	V _{SD}		-0.7	-1	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss		2747		pF	V _{DS} = -20V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss		508	_			
Reverse Transfer Capacitance	Crss		222	_			
Gate Resistance	Rg	_	21.4	—	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz	
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	25	—		V _{DS} = -20V, I _D = -9.8A	
Total Gate Charge (V _{GS} = -10V)	Qg		52	_	nC		
Gate-Source Charge	Q _{gs}	_	8.5	—	ne		
Gate-Drain Charge	Q _{gd}	_	11.8				
Turn-On Delay Time	t _{D(ON)}	_	6.6			$\label{eq:VGS} \begin{array}{l} V_{GS} = -10V, \ V_{DD} = -20V \\ R_g = 6\Omega, \ I_D = -1A \end{array}$	
Turn-On Rise Time	tR	_	6.5		1		
Turn-Off Delay Time	t _{D(OFF)}		222		ns		
Turn-Off Fall Time	tF		138				
Reverse Recovery Time	t _{RR}		25		ns	I _F = -9.8A, di/dt = -100A/µs	
Reverse Recovery Charge	Q _{RR}		17		nC	I _F = -9.8A, di/dt = -100A/µs	

Notes: 9. Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to production testing.



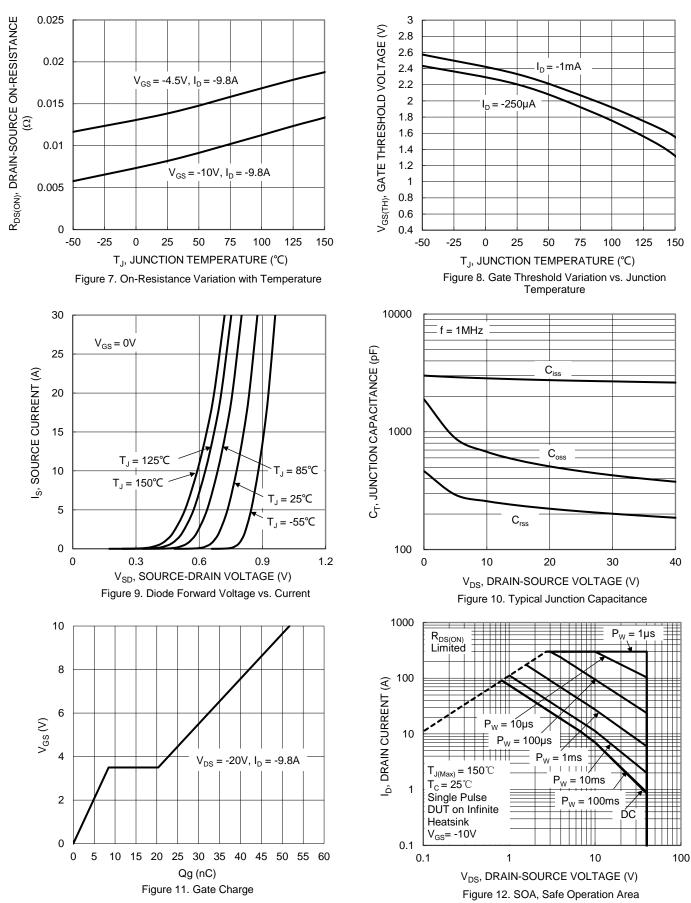
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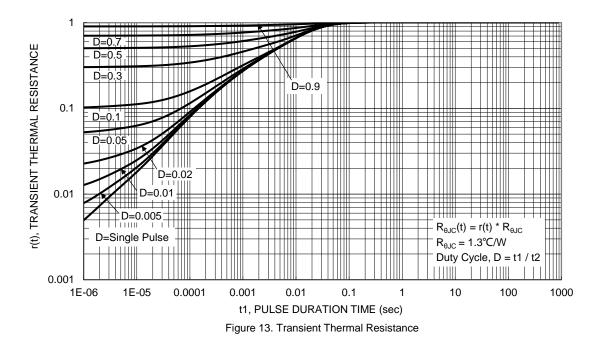
DMP4011SPSWQ Document number: DS43104 Rev. 2 - 2



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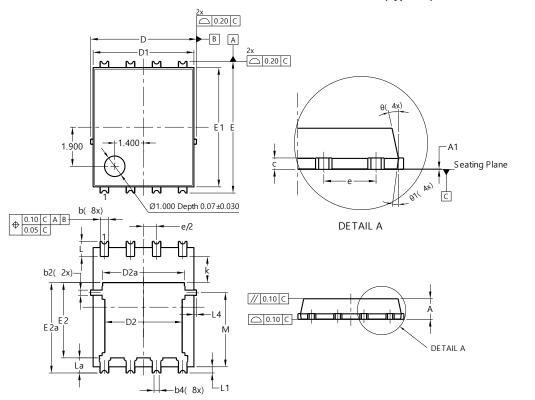






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



PowerDI5060-8/SWP (Type UX)

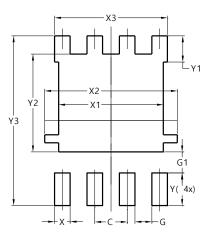
(Type UX)						
Dim	Min	Max	Тур			
Α	0.90	1.10	1.00			
A1	0	0.05				
b	0.30	0.50	0.41			
b2	0.20	0.35	0.25			
b4	().25REF				
С	0.230	0.330	0.277			
D	5	.15 BS0	0			
D1	4.70	5.10	4.90			
D2	3.56	3.96	3.76			
D2a	3.78	3.98				
E	6	.40 BS0	2			
E1	5.60	6.00	5.80			
E2	3.46	3.86	3.66			
E2a	4.195	4.595	4.395			
е	1	.27BSC)			
k	1.05					
L	0.635	0.835	0.735			
La	0.635	0.835	0.735			
L1	0.200	0.400	0.300			
L4	0.025	0.225	0.125			
М	3.205	4.005	3.605			
θ	10°	12°	11°			
θ1	6°	8°	7°			
All	All Dimensions in mm					

PowerDI5060-8/SWP

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	5.190		
X3	4.420		
Ŷ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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